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Patent

Customer No.: 31561
Application No.: 10/710,662
Docket No. 12336-US-PA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Jui-Tsen Huang
Application No. : 10/710,662
Filed : July 27, 2004
For : METHOD OF RELIEVING WAFER STRESS
Art Unit : 2813
Examiner : HARRISON, MONICA D

TRANSMITTAL LETTER
+1-571-273-8300
(Via fax: 1+2+10 pages)

ASSISTANT COMMISSIONER FOR PATENTS
Alexandria, VA 22314

Dear Sir,

In response to the Final Office Action dated April 27, 2007, please find the relevant papers as follows:

- Request for Continued Examination in (2) pages;
- Preliminary Amendment in (10) pages.

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

Respectfully Submitted,
JIANQ CHYUN Intellectual Property Office

Date: July 23, 2007

By: Belinda Lee
Belinda Lee
Registration No.: 46,863

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